

PRODUCT DATA SHEET

WS-366 Interconnect Flux

Introduction

WS-366 Interconnect Flux is a high-viscosity paste-type flux designed for use in BGA bumping and board level attachment. It can also be used wherever a water-soluble flux with excellent cleanability is desired.

Features

- Excellent cleanability, residue can be removed with room temperature water
- Can be used for printing, dipping, and pin transfer deposition
- Offers high yields in BGA bumping process
- Excellent solderability
- Wide process window
- Suitable for Sn/Pb, Pb-free, and high lead-containing applications
- Designed for flip-chip applications

Properties

Flux Type Classification	H1
Color	Amber to brown
Stencil Life	>8 hours at room temperature
Shelf Life	6 months at -20 to +5°C 3 months at 5 to 25°C
SIR (Ohms, post cleaning)	Pass (>10 ⁸ after 7 days @ 85°C and 85% RH)
Typical Viscosity: Brookfield	425kcps at 5rpm
Halide Content	<3% Cl equivalent
Acid Value	30–50
Tack Strength	100–400g

All information is for reference only.

Not to be used as incoming product specifications.

Packaging

WS-366 is available in SEMCO cartridges, 100g jars or 10–150g syringes; however, other packaging can be provided to meet specific requirements.

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Cleaning

DI water or water plus cleaner that is room temperature or higher for >1 minute at >60psi.

Reflow

Peak reflow temperature should be <350°C in an air or nitrogen atmosphere, with a linear ramp up to 30°C above solidus temperature.

Storage

WS-366 syringes and cartridges should be stored tip down at 0–25°C. **WS-366** should be allowed to stand for 4 hours at room temperature before using.



Technical Support

Indium Corporation's internationally experienced engineers provide in-depth technical assistance to our customers. Thoroughly knowledgeable in all facets of Material Science as it applies to the electronics and semiconductor sectors, Technical Support Engineers provide expert advice in solder properties, alloy compatibility and selection of solder preforms, wire, ribbon, and paste. Indium Corporation Technical Support engineers provide rapid response to all technical inquiries.

Safety Data Sheets

The SDS for this product can be found online at: <http://www.indium.com/sds>



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